

UMB05F Thru UMB10F Ultra Miniature Glass Passivated Single-Phase Surface Mount Flat Bridge Rectifier

Features

- Low profile space
- Ideal for automated placement
- Glass passivated chip junctions
- Low forward voltage drop
- Low leakage current
- High forward surge capability
- High temperature soldering:
260°C/10 seconds at terminals
- Component in accordance to
RoHS 2011/65/EU and WEEE 2002/96/EC



SOF2-4



RoHS
COMPLIANT

Major Ratings and Characteristics

$I_{F(AV)}$	0.5A,0.8A
V_{RRM}	50V to 1000V
I_{FSM}	20A
I_R	5.0 μ A
V_F	1.1V
$T_{jmax.}$	150°C

Mechanical Data

- **Case:**SOF2-4
Molding compound meets
UL 94 V-0 flammability rating
- **Terminals:** Solder plated, solderable per
MIL-STD-750, Method 2026
- **Polarity:** Polarity symbols marked on body
- **Marking:** type number

Marking:



Marking meaning

UMB05F= Marking Code

Maximum Ratings & Thermal Characteristics ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Items	Symbol	UMB 05F	UMB 1F	UMB 2F	UMB 4F	UMB 6F	UMB 8F	UMB 10F	Unit
Maximum repetitive peak reverse voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS reverse voltage	V_{RMS}	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	V_{DC}	50	100	200	400	600	800	1000	V
Maximum average forward rectified current at T_A (see Fig1.) -on glass-epoxy P.C.B. ⁽¹⁾ -on aluminum substrate ⁽²⁾	$I_{F(AV)}$	0.5 0.8							A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load	I_{FSM}	20							A
Thermal resistance from junction to ambient per leg	$R_{\theta JA}^{(1)}$ $R_{\theta JA}^{(2)}$	100 80							°C/W
Thermal resistance from junction to lead per leg	$R_{\theta JL}^{(1)}$	30							
Operating junction and storage temperature range	T_J, T_{STG}	-55 to +150							°C

Note: 1.On glass epoxy P.C.B. mounted on 0.06" x 0.04" (1.5mm x 1.1mm) pads

2.On aluminum substrate P.C.B. with an area of 0.8x0.8"(20x20mm) mounted on 0.06x0.04"(1.5x1.1mm) solder pad

Electrical Characteristics (T_A = 25 °C unless otherwise noted)

Items	Test conditions	Symbol	Min	Type	Max	Unit
Instantaneous forward voltage per leg	I _F =0.4A ⁽³⁾	V _F	-	0.96	1.1	V
Reverse current per leg	V _R =V _{DC} T _A =25°C T _A =125°C	I _R			5.0 100.0	μA

Characteristic Curves (T_A=25 °C unless otherwise noted)

Fig.1 Output Current Derating Curve

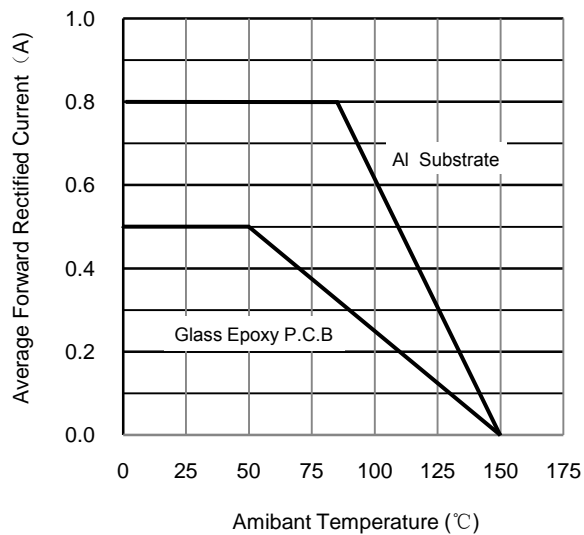


Fig.2 Maximum Peak Forward Surge Current(per leg)

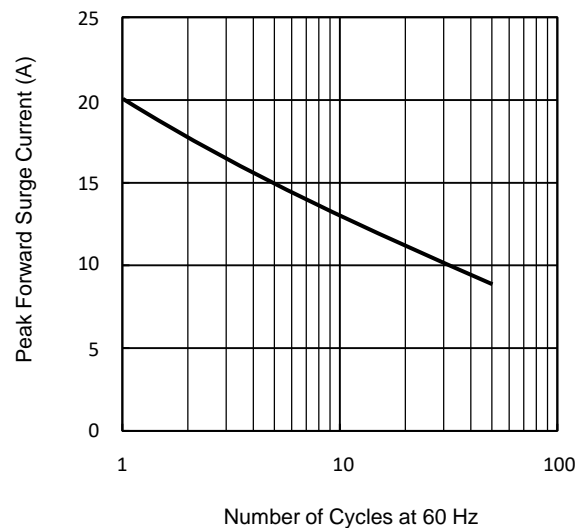


Fig.3 Typical Forward Characteristics (per leg)

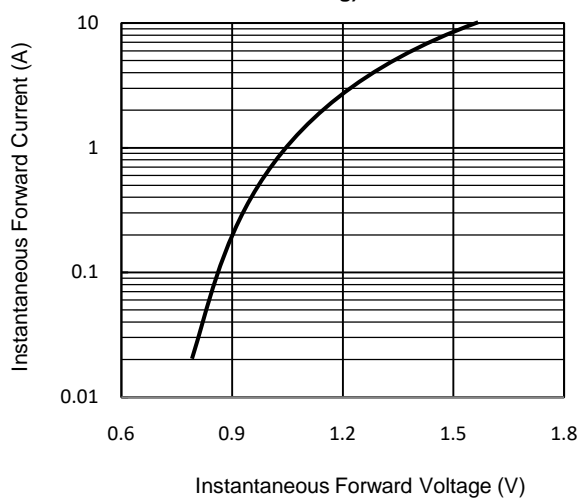
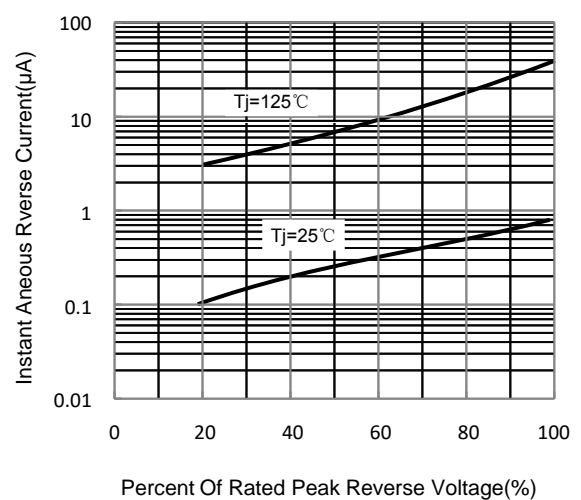
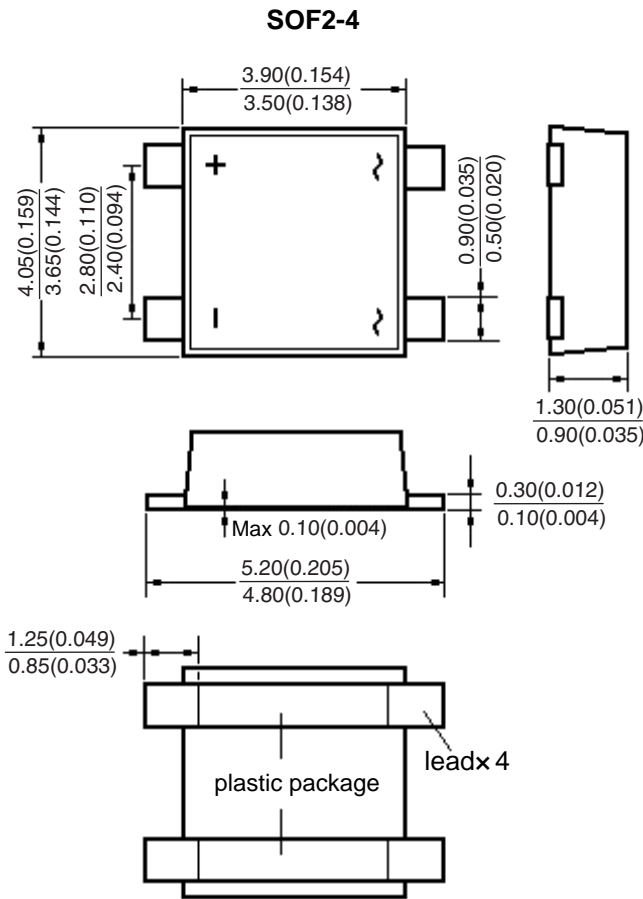


Fig.4 Typical Reverse Characteristics

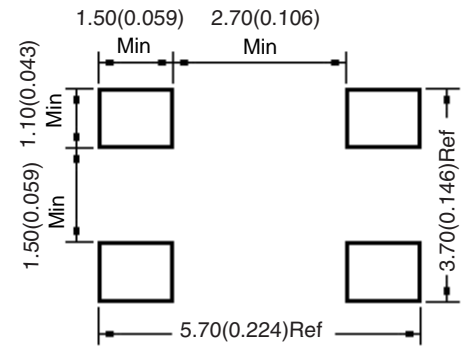


Package Outline



Dimensions in millimeters and (inches)

Mounting Pad Layout



Dimensions in millimeters and (inches)

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